

- **Members of the Texas Instruments Widebus™ Family**
- **Inputs Are TTL-Voltage Compatible**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **EPIC™ (Enhanced-Performance Implanted CMOS) 1- μ m Process**
- **500-mA Typical Latch-Up Immunity at 125°C**
- **Package Options Include Shrink Small-Outline 300-mil (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings**

description

The 'ACT16470 are 16-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. They can be used as two 8-bit transceivers or one 16-bit transceiver. Separate clock (CLKAB or CLKBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. If both CEAB and CLKAB are low, then B port will have the level of A port prior to the most recent low-to-high transition of CLKAB. Data flow from B to A is similar, but requires the use of CEBA, CLKBA, and OEBA inputs.

To avoid false clocking of the flip-flops, CE should not be switched from high to low while CLK is high.

The 74ACT16470 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16470 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16470 is characterized for operation from -40°C to 85°C.

54ACT16470 . . . WD PACKAGE
 74ACT16470 . . . DL PACKAGE
 (TOP VIEW)

1OEAB	1	56	1OEBA
1CLKAB	2	55	1CLKBA
1CEAB	3	54	1CEBA
GND	4	53	GND
1A1	5	52	1B1
1A2	6	51	1B2
V _{CC}	7	50	V _{CC}
1A3	8	49	1B3
1A4	9	48	1B4
1A5	10	47	1B5
GND	11	46	GND
1A6	12	45	1B6
1A7	13	44	1B7
1A8	14	43	1B8
2A1	15	42	2B1
2A2	16	41	2B2
2A3	17	40	2B3
GND	18	39	GND
2A4	19	38	2B4
2A5	20	37	2B5
2A6	21	36	2B6
V _{CC}	22	35	V _{CC}
2A7	23	34	2B7
2A8	24	33	2B8
GND	25	32	GND
2CEAB	26	31	2CEBA
2CLKAB	27	30	2CLKBA
2OEAB	28	29	2OEBA



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54ACT16470, 74ACT16470
16-BIT REGISTERED TRANSCEIVERS
WITH 3-STATE OUTPUTS

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FUNCTION TABLE†

INPUTS				OUTPUT B
CEAB	CLKAB	<u>OEAB</u>	A	
H	X	X	X	Z
X	X	H	X	Z
L	L	L	X	B_0^{\ddagger}
L	↑	L	L	L
L	↑	L	H	H

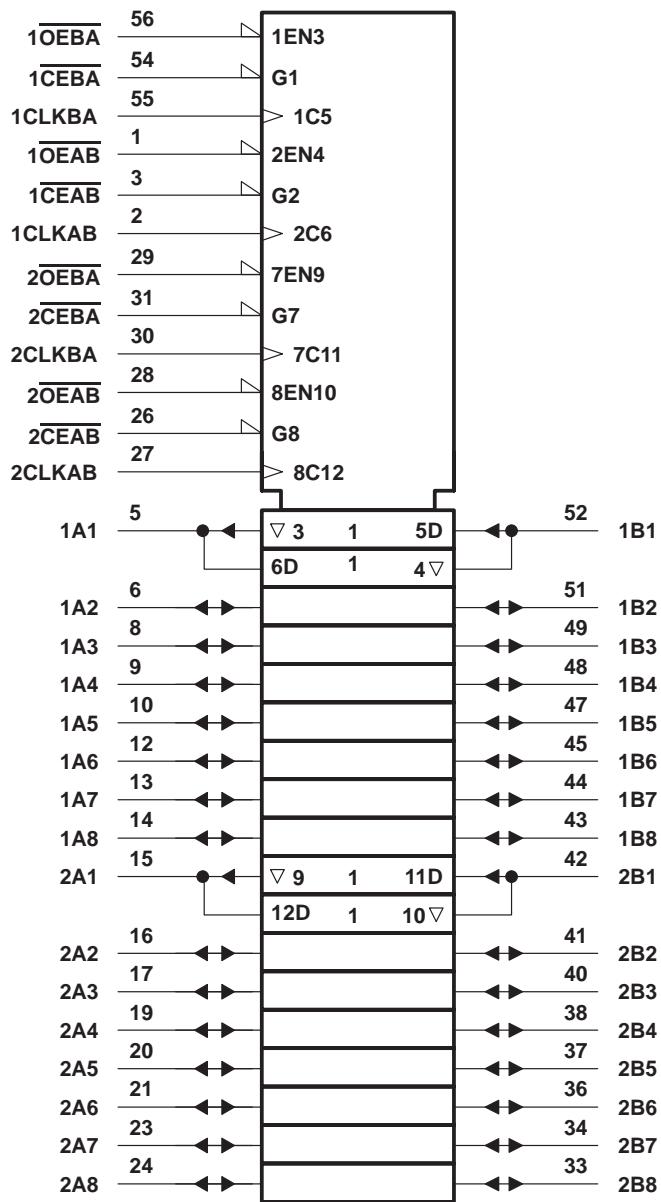
† A-to-B data flow is shown; B-to-A flow is similar but uses CEBA, CLKBA, and OEBA.

‡ Output level before the indicated steady-state input conditions were established



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logic symbol†

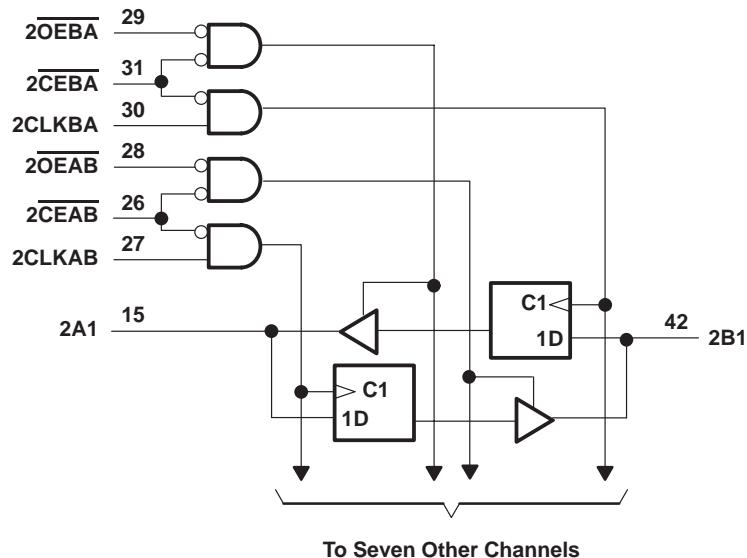
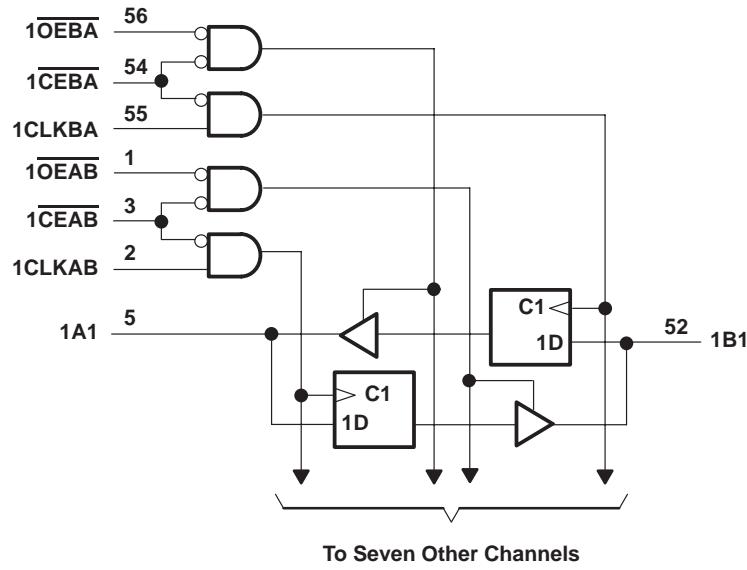


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 to 7 V		
Input voltage range, V_I (see Note 1)	–0.5 to V_{CC} + 0.5 V		
Input voltage range, V_O (see Note 1)	–0.5 to V_{CC} + 0.5 V		
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA		
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA		
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA		
Continuous current through V_{CC} or GND	±400 mA		
Maximum power package dissipation at $T_A = 55^\circ\text{C}$ (in still air)(see Note 2): DL package	1.4 W		
Storage temperature range, T_{stg}	–65°C to 150°C		

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 3)

		54ACT16470			74ACT16470			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
V_I	Input voltage	0	V_{CC}		0	V_{CC}		V
V_O	Output voltage	0	V_{CC}		0	V_{CC}		V
I_{OH}	High-level output current			–24			–24	mA
I_{OL}	Low-level output current			24			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10		0	10		ns/V
T_A	Operating free-air temperature	–55		125	–40		85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			54ACT16470	74ACT16470	UNIT
			MIN	TYP	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 µA	4.5 V	4.4			4.4	4.4	V
		5.5 V	5.4			5.4	5.4	
	I _{OH} = -24 mA	4.5 V	3.94			3.8	3.8	
		5.5 V	4.94			4.8	4.8	
	I _{OH} = -75 mA [†]	5.5 V				3.85	3.85	
V _{OL}	I _{OL} = 50 µA	4.5 V		0.1		0.1	0.1	V
		5.5 V		0.1		0.1	0.1	
	I _{OL} = 24 mA	4.5 V		0.36		0.44	0.44	
		5.5 V		0.36		0.44	0.44	
	I _{OL} = 75 mA [†]	5.5 V				1.65	1.65	
I _I	Control inputs	V _I = V _{CC} or GND	5.5 V		±0.1		±1	±1 µA
I _{OZ} [‡]	A or B ports	V _O = V _{CC} or GND	5.5 V		±0.5		±5	±5 µA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	5.5 V		8	80	80	µA
ΔI _{CC} [§]		One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V		0.9	1	1	mA
C _i	Control inputs	V _I = V _{CC} or GND	5 V		3			pF
C _{io}	A or B ports	V _O = V _{CC} or GND	5 V		11.5			pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[‡] For I/O ports, the parameter I_{OZ} includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

**timing requirements over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)**

		T _A = 25°C		54ACT16470		74ACT16470		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	0	55	0	55	0	55	MHz
t _w	Pulse duration	4		4		4		ns
		8.5		8.5		8.5		
t _{su}	Setup time, data before CLK↑	6		6		6		ns
t _h	Hold time, data after CLK↑	1		1		1		ns

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			54ACT16470		74ACT16470		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			55			55		55		MHz
t_{PLH}	CLK	A or B	3.9	8.3	10.3	3.9	11.8	3.9	11.8	ns
t_{PHL}			3.8	8.4	10.3	3.8	11.7	3.8	11.7	
t_{PZH}	\overline{OE}	A or B	3.2	8.3	10.5	3.2	11.9	3.2	11.9	ns
t_{PZL}			3.6	9.5	11.8	3.6	13.4	3.6	13.4	
t_{PHZ}	\overline{OE}	A or B	4.6	7.4	9.3	4.6	9.9	4.6	9.9	ns
t_{PLZ}			4.6	7	8.8	4.6	9.5	4.6	9.5	
t_{PZH}	\overline{CE}	A or B	3.5	8.8	10.9	3.5	12.5	3.5	12.5	ns
t_{PZL}			4.2	10.1	12.4	4.2	14.3	4.2	14.3	
t_{PHZ}	\overline{CE}	A or B	5.2	8.3	10.3	5.2	11.2	5.2	11.2	ns
t_{PLZ}			5.2	7.9	10	5.2	10.9	5.2	10.9	

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS		TYP	UNIT
C_{pd}	Power dissipation capacitance per transceiver	Outputs enabled	$C_L = 50 \text{ pF}$, $f = 1 \text{ MHz}$	59	pF
		Outputs disabled		39	

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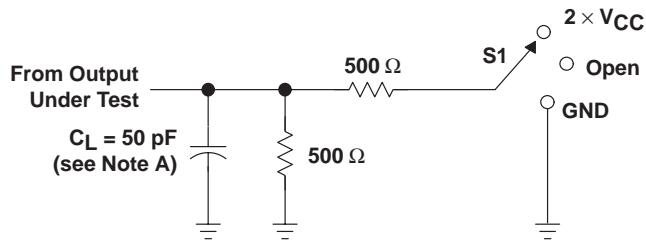


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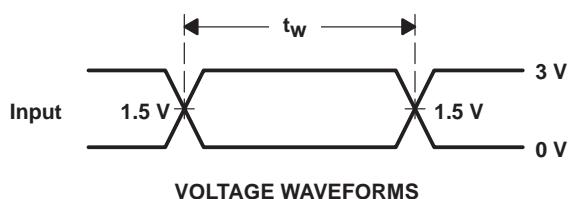
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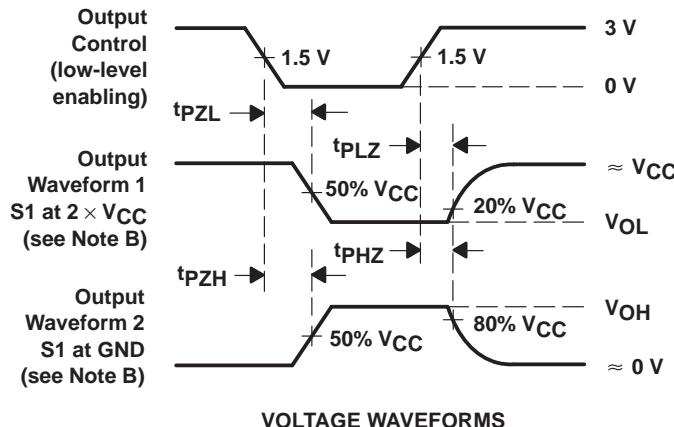
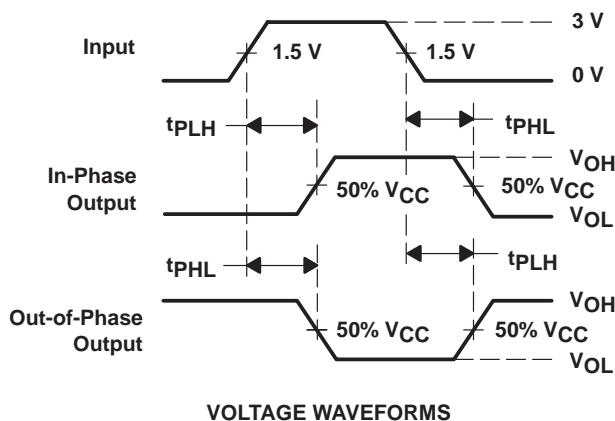
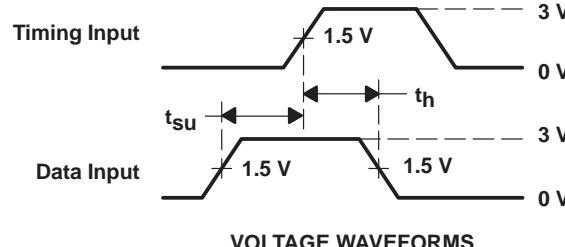
PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND



NOTES:

- C_L includes probe and jig capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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